

Lanthanide-Assisted Deposition of Strongly Electro-optic PZT Thin Films on Silicon: Toward Integrated Active Nanophotonic Devices

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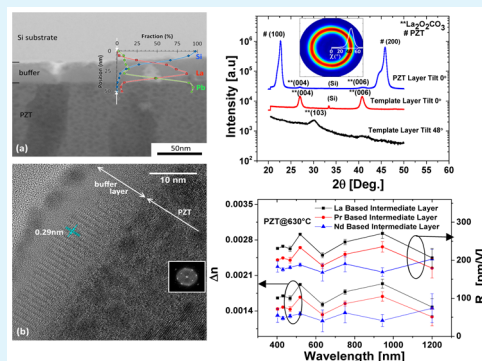
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Supporting Information

ABSTRACT: The electro-optical properties of lead zirconate titanate (PZT) thin films depend strongly on the quality and crystallographic orientation of the thin films. We demonstrate a novel method to grow highly textured PZT thin films on silicon using the chemical solution deposition (CSD) process. We report the use of ultrathin (5–15 nm) lanthanide (La, Pr, Nd, Sm) based intermediate layers for obtaining preferentially (100) oriented PZT thin films. X-ray diffraction measurements indicate preferentially oriented intermediate $\text{Ln}_2\text{O}_2\text{CO}_3$ layers providing an excellent lattice match with the PZT thin films grown on top. The XRD and scanning electron microscopy measurements reveal that the annealed layers are dense, uniform, crack-free and highly oriented (>99.8%) without apparent defects or secondary phases. The EDX and HRTEM characterization confirm that the template layers act as an efficient diffusion barrier and form a sharp interface between the substrate and the PZT. The electrical measurements indicate a dielectric constant of ~ 650 , low dielectric loss of ~ 0.02 , coercive field of 70 kV/cm, remnant polarization of $25 \mu\text{C}/\text{cm}^2$, and large breakdown electric field of 1000 kV/cm. Finally, the effective electro-optic coefficients of the films are estimated with a spectroscopic ellipsometer measurement, considering the electric field induced variations in the phase reflectance ratio. The electro-optic measurements reveal excellent linear effective pockels coefficients of 110 to 240 pm/V, which makes the CSD deposited PZT thin film an ideal candidate for Si-based active integrated nanophotonic devices.

KEYWORDS: chemical solution deposition, electro-optic effect, ellipsometry, dielectric, lead zirconate titanate, modulator, pockels coefficient



INTRODUCTION

The deposition of high quality ferroelectric thin films has been studied extensively over the past few decades, because of the excellent piezo-electric,¹ pyro-electric,² ferro-electric,³ and electro-optic⁴ properties. The presence of functional properties in many ferroelectric materials has motivated the heterogeneous integration of crystalline thin films directly on silicon for the realization of a variety of novel devices. Among the known ferroelectric thin film oxides, lead zirconate titanate (PZT) exhibits a large dielectric constant, piezo-electric coefficient^{5,6} and electro-optic coefficient,⁴ which already lead to applications in ferro-electric thin film capacitors,⁷ piezo-electric actuators,⁸ and electro-optic modulators.^{9,10} Recent advancements in the thin film technology show nanograined PZT film¹¹ with excellent ferroelectric properties.^{11,12} Novel devices with PZT nanofiber have been demonstrated for mechanical energy harvesting.¹³ Other interesting properties of the films such as the electron emission characteristics are also explored with

nanograined PZT structures, and a low turn on electric field is reported.¹⁴ Although the ferroelectric thin films are explored mostly for electronic applications, the ever increasing demand for higher bandwidth meanwhile putting constraints on power consumption, has resulted in an increasing interest toward the use of the films in the optical domain. To realize optical data transmission, for example, for chip-to-chip interconnects, integrated optical devices which are compatible with the electrical systems are indispensable. The well-established ferroelectric oxide based technologies propelled the development of high-speed electro-optic devices on different material platforms, however the silicon based photonics technologies have not explored the strong linear electro-optic (EO) properties of PZT thin films.¹⁵ The current state of the art

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high-speed integrated optical devices are based on LiNbO₃ single crystals.¹⁶ However, replacing them with ferroelectric thin film oxides such as PZT, along with the compact silicon photonic platform, could be an alternative to realize smaller, functional and power efficient devices.^{10,17–19}

A variety of methods has been used to develop ferroelectric thin films: chemical solution deposition (CSD),²⁰ RF magnetron sputtering,²¹ metal organic chemical vapor deposition (MOCVD)²² and pulsed laser deposition (PLD).²³ However, the direct deposition of PZT on silicon still remains a challenge. It is reported that there is interdiffusion between Si and PZT thin film at a high annealing temperature, which makes it hard to form the perovskite PZT phase.²⁴ Different methods have been proposed and demonstrated to use either a seed or a barrier layer to promote thin film growth.²⁵ The nucleation of the PZT thin films strongly depends on the underlying substrate and the interface properties.²⁶ The dielectric, piezoelectric and electro-optical properties of the thin films depend strongly on the crystal orientation. It has been reported that strongly *c*-axis-oriented PZT thin films can be grown on either single-crystalline oxide substrates or by using a preferentially oriented thick (>100 nm) conductive or dielectric intermediate buffer layer.²⁷ Metallic intermediate layers are preferred for electrical devices, but often such layers cannot be used for electro-optical devices because the optical absorption is too high. A thick intermediate layer is not necessarily a drawback for certain applications of PZT, but for other applications such as electro optical devices the performance is severely limited by the thickness of this layer. However, recent works show advancements toward micro and nano scale EO devices on the silicon platform based on complex and costly layer bonding approaches²⁸ and with the more sophisticated epitaxially grown ferroelectric oxides.¹⁰

In this work, we demonstrate a novel technique to realize textured PZT thin films on a variety of substrates such as bare silicon, glass (corning glass type CB90IN (Delta Technologies)), glass/ITO, Si/Al₂O₃, Si/SiO₂, and Si/Si₃N₄, with a conventional 2-methoxy ethanol based CSD technique.²⁷ Ultrathin dielectric intermediate layers of 5 to 10 nm have been used as an efficient intermediate layer to promote the thin film growth. The previous reported methods that use thin template layers are either based on epitaxially grown SrTiO₃²⁹ intermediate layers of 4–10 nm by molecular beam epitaxy (MBE) or on a thin intermediate thermally grown intermediate SiO₂ layer with thickness ranging from 5 to 10 nm.²⁴ The SrTiO₃ template layer results in epitaxial PZT thin films, but this growth technique is limited to crystalline substrates (Si), whereas in the latter technique the phase purity of the films critically depends on the SiO₂ thickness. The possibility of chemical reaction at the PZT/SiO₂/Si interface at high temperature has also not been discussed there. In this work, the annealing temperature is significantly lower, while the film quality is quasi-independent of the type of substrate or the intermediate layer thickness.

■ EXPERIMENTAL SECTION

Solution Preparation. We use lanthanide-based thin films as intermediate layers for the PZT deposition. Nitrate salts of the lanthanides (La, Pr, Nd, Sm) are dissolved in propanol, and refluxed for 24 h at room temperature. The molarity of the solution is 0.02 M, which results in layers of about 10 nm thickness, upon spin coating and subsequent heat treatment. The PZT (52/48) precursor solution is prepared with a 20 mol % excess of lead to compensate for lead loss

during the crystallization heat treatments. We follow a 2-methoxy ethanol based chemical solution route, using acetyl acetone as a chelating agent. First, the lead acetate hydrate salt is dissolved in 2-methoxy ethanol and vacuum distilled for 3 h. Later, Ti-isopropoxide and Zr-isopropoxide solutions are mixed and chelated in stoichiometric proportion inside a glovebox, before it was mixed with the distilled lead acetate to get the final solution. The molarity of the final solution is 0.4 M.

Deposition Procedure. First, the intermediate layers are spin-coated onto the substrate at 3000 rpm for 40 s, and heat treated on a hot plate at 200 °C for 2 min. Subsequently, the layers are annealed at 400 to 500 °C in a tube furnace. Upon annealing the films undergo a sequence of endothermic weight loss reactions to initiate the intermediate phase transformation.³⁰ As the molarity of the solution is increased to get a larger thickness for the intermediate layers, it is noticed that the nonuniformity of the spin-coated layers also increased. To avoid this problem, we have followed a multilayer spin-coating and annealing procedure. Each individual layer is spin coated and subsequently annealed in air, and this process is repeated over several cycles to achieve a desired thickness. Intermediate layers of 5–80 nm have been prepared with this procedure. Second, the PZT precursor solution is spin-coated onto the intermediate layer, at 3500 rpm for 40 s, followed by pyrolysis at 300 °C to burn out the organic components. Each spin coating and pyrolysis step results in a layer of about 50 nm, so the process cycle is repeated 4 times to obtain a film of thickness 200 nm, prior to the annealing process.

Subsequently, the amorphous PZT thin films are annealed in a tube furnace at 500 to 600 °C, under flowing O₂ gas, 10–20 min, to allow crystallization into the perovskite PZT phase. A steady oxygen flow of 150 Liter/hour is maintained throughout the annealing procedure. The ramping rates for heating and cooling of the specimen in the annealing system are 100 and –50 °C/min, respectively. This process is repeated until a desired thickness of the PZT film is achieved.

X-ray Diffraction Measurements. The samples are first cleaned with acetone, isopropanol, and deionized water. The measurements are carried out with a D8 Discover diffractometer (Bruker technologies Ltd.) with CuK α radiation. The diffractograms are recorded for 2θ angles between 15° and 64°, with step size 0.004° and time step 1.2 s.

Focused Ion Beam Etching/Scanning Electron Microscopy. The cross section images and the transmission electron microscope (TEM) slices of the specimens are prepared by a FEI Nova 600 Nanolab Dual-Beam Focused Ion Beam system (FIB) and associated scanning electron microscope (SEM). It allows simultaneous milling and imaging of the specimens. The SEM column is equipped with a high-performance field-emission gun electron source, whereas the FIB system has a gallium Liquid Metal Ion Source (LMIS).

(Scanning) Transmission Electron Microscopy. Transmission electron microscopy (TEM) analysis is performed using a JEM-2200FS FEG-TEM (Jeol), operated at 200 keV, and equipped with an in-column omega filter to reduce chromatic aberration. Energy dispersive X-ray (EDX) spectroscopy was used to measure the chemical composition in scanning TEM mode (STEM).

Atomic Force Microscopy. The surface roughness of the PZT thin films are measured by Atomic Force Microscopy (AFM) analysis. The measurements are carried out with a Digital Instruments Dimension 3100 scanning probe microscope with a nanoscope IIIa controller in contact mode.

C–V, C–F, and I–V Characteristics. Prior to the measurements, a top electrode is deposited with either chromium (Cr) or indium tin oxide (ITO) (area = 3.14 mm², thickness 50–100 nm) by e-gun evaporation. The C–V and C–F (up to 1 MHz) characteristics are measured with a HP4192ALF impedance analyzer. The capacitance is measured for a small AC voltage (oscillation level ~0.1 V) which is superposed on a DC voltage offset. I–V measurement are performed with a Keithley 236 source measure unit.

P–E Hysteresis Measurements. A Sawyer–Tower circuit is used to measure the hysteresis loop in the polarization–electric field diagram of the PZT films. The measurements are carried out at frequencies in the range from 100 Hz to 1 kHz with a sinusoidal ac-voltage with an amplitude of 10 V peak-to-peak.

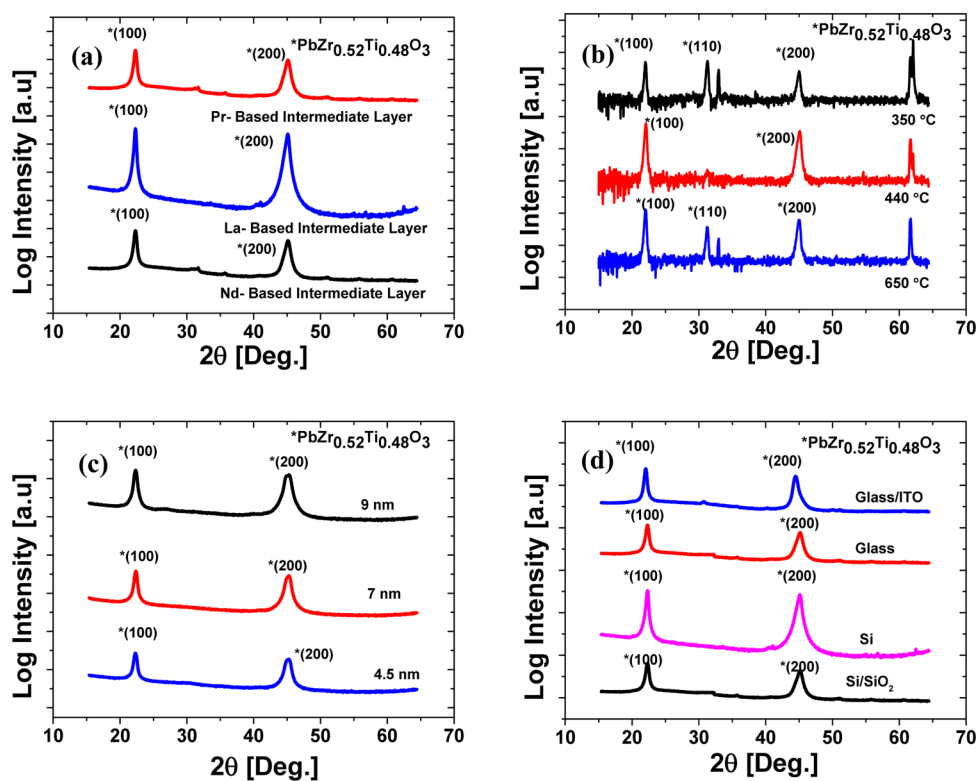


Figure 1. XRD patterns of PZT thin films annealed at 600 °C. (a) PZT on intermediate layers of La, Pr, and Nd, which are heat treated at 500, 450, and 440 °C, respectively. (b) On Nd-based intermediate layers of 10 nm, which has been heat treated at different temperatures. (c) PZT on Si substrates coated with La-based buffer layers of different thickness (heat treated at 500 °C). (d) PZT films on different substrates coated with La-based intermediate layers (thickness ~10 nm, heat treated at 500 °C).

Spectroscopic Ellipsometer Measurements. Electro-optic characterizations of the PZT thin films are carried out with a spectroscopic ellipsometer (J. A. Woollam Co.). The ellipsometer is equipped with a Xe lamp source, with a rotating polarizer and analyzer.

RESULTS AND DISCUSSION

The thickness of the PZT film used for the XRD measurement is determined as 200 ± 3 nm from spectroscopic ellipsometry measurements. Figure 1a represents a comparison between the X-ray diffractograms of the PZT thin films (annealed at 600 °C) deposited on silicon substrates coated with intermediate layers of La, Pr, and Nd, which are heat treated at 500, 450, and 440 °C, respectively. The thickness of the intermediate layer is approximately 10 nm for this experiment. Regardless of the PZT processing conditions, such as pyrolysis temperature, pyrolysis time, or annealing temperature, the PZT films deposited onto these intermediate layers are crystallized into a pure perovskite phase, with no evidence of any intermediate secondary phase formation. The diffractograms show strong diffraction peaks along the (100) and (200) crystallographic orientations at $2\theta = 22^\circ$, with either tetragonal or rhombohedral structure. Figure 1b represents the XRD patterns of the PZT films (annealed at 600 °C) deposited on Nd-based intermediate layer, which are heat treated at different temperatures. It is evident that the layers that are heat treated at 350 and 650 °C show a mixed (100) and (110) orientation, whereas the intermediate layer heat treated at 440 °C results in a strong (100) preferential orientation. The heat treatment of the intermediate layer influences the nucleation mechanism, which results in different diffraction peaks in the XRD spectrum. It has been reported that heat treatment initiates

the transformation of the nitrate film into different crystalline states of $\text{NdO}_{0.5}\text{NO}_2$, NdONO_3 , and Nd_2O_3 at 350, 440, and 650 °C, respectively. Even though many crystalline phases exist on the thermal decomposition of $\text{Nd}(\text{NO}_3)_3 \cdot 6\text{H}_2\text{O}$,³¹ we found that the intermediate phase obtained after a heat treatment around 440 °C is the only one resulting in oriented thin film growth. Furthermore, during the heat treatment LnO_2CO_3 is formed rather than the mixed $\text{Ln}(\text{O},\text{N})$ compounds, as will be motivated below,^{32,33,31} Figure 1c shows the X-ray diffractograms of the PZT thin films (annealed at 600 °C) deposited on Si substrates coated with a La-based intermediate layer (heat treated at 500 °C) of different thicknesses. When the intermediate layer thickness is only 3 nm, the intermediate layers are not efficient to prevent the interdiffusion of Si and PZT, and only the pyrochlore PZT phase is observed. A similar result has been reported before with PZT film on ultrathin intermediate SiO_2 of thickness <4 nm.²⁴ However, as the intermediate layer thickness increases above 5 nm, well-defined diffraction peaks corresponding to the stoichiometric PZT are observed along the (100) and (200) crystallographic directions. The same experiments are repeated on different substrates including Si, glass, glass/ITO, $\text{Si}/\text{Al}_2\text{O}_3$, Si/SiO_2 , and $\text{Si}/\text{Si}_3\text{N}_4$. An apparent peak shift observed for the glass/ITO sample is due to the minor misalignment. All the PZT thin films show identical crystallographic orientation and similar properties, regardless of the substrate material. This indicates that the orientation of the thin film is not influenced by the substrate, and depends only on the nature of the intermediate layer. The minimum thickness of the intermediate layer required on bare silicon and glass substrates to avoid microcracks after high

temperature annealing is estimated to be in the range of 9–15 nm.

To analyze the mechanism of thin film growth, thicker La-intermediate layers (~60 nm) are formed by repeating the spin coating and heat treatment procedure, without deposition of PZT on top. It is found that upon heat treatment at 500 °C, the intermediate nitrate layer reacts with the CO₂ present in the ambient air, resulting in the formation of tetragonal La₂O₂CO₃³¹ ($a = 4.07$ Å, $c = 13.49$ Å). The XRD pattern shown in Figure 2 indicates that the intermediate layers have a

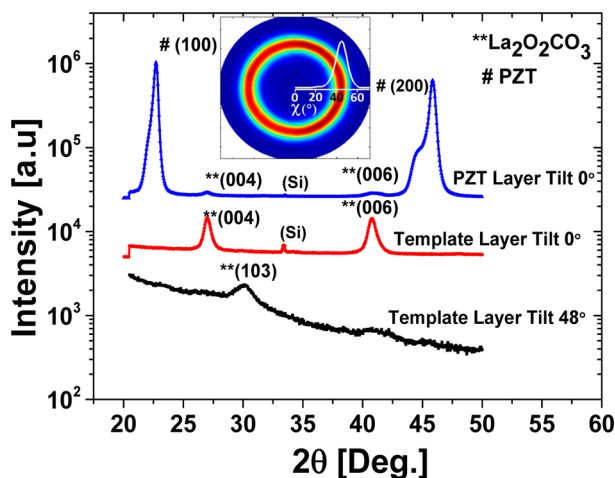


Figure 2. XRD pattern of the La-based intermediate layer, heat treated at 500 °C in air at a tilt angle of 0° and 48°. Inset: X-ray pole figure of the PZT thin film at $2\theta = 30.95^\circ$ (showing the diffraction intensity of the (110) reflection as a function of tilt angle).

strong preferential growth with the c -axis perpendicular to the substrate, showing a good lattice match (mismatch in the a -axis parameters <0.7%) to PZT. The formation of La₂O₂CO₃ is further confirmed upon recording the XRD at a tilt angle \sim of 48°, bringing the (103) plane into diffraction (Figure 2). When annealing the intermediate layers in pure oxygen at low pressure, no distinct diffraction peaks are found, confirming that the formation of the carbonate compound plays a key role in the strong preferential orientation of the PZT thin film. The conclusions derived from X-ray diffraction are consistent with the microscopic behavior of the buffer layer, as studied with STEM and HRTEM (Figure 3b).

On the basis of the STEM image, it is clear that the La₂O₂CO₃ layer acts as an efficient buffer layer between the Si substrate and the PZT layer. Also, the brightness variations in the PZT layer suggest the onset of the growth of columnar grains. A line scan by means of EDX was recorded to study the chemical composition of the buffer layer. The La₂O₂CO₃ thin film indeed acts as an efficient buffer layer between the substrate and the PZT thin film (Figure 3a), since the compositional gradient for the representative elements Si, La, and Pb is steep, taking into account the typical spatial resolution of EDX in STEM. The HRTEM image (Figure 3b) confirms the crystalline nature of the buffer layer. In addition, the c -axis is found to be perpendicular to the interface between the PZT and buffer layer, in line with the texture analysis (Figure 2). Furthermore, the PZT layer is well crystallized, starting at the interface with the buffer layer. Again, the crystallographic orientation, as observed from the FFT power spectrum, is in line with the X-ray diffraction

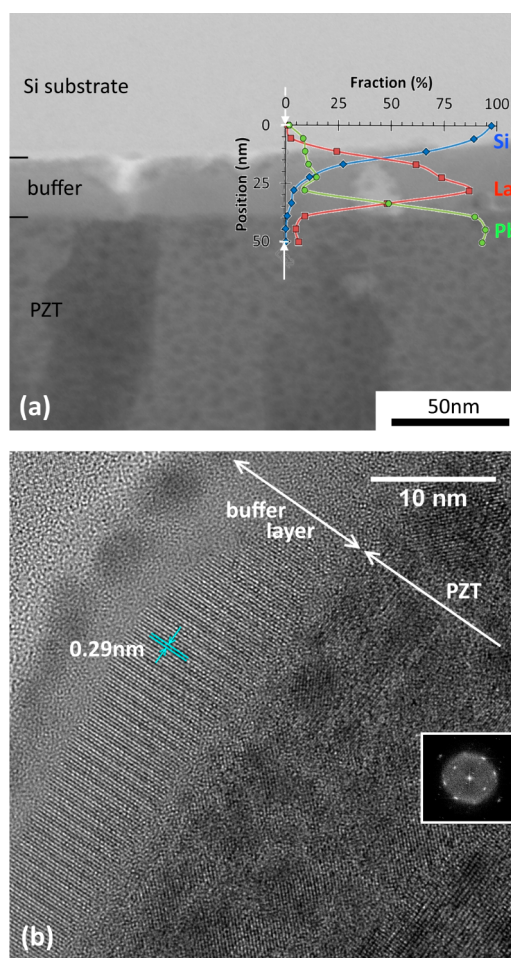


Figure 3. (a) STEM image of the cross section of the PZT thin film (annealed at 630 °C) on top of the La₂O₂CO₃ buffer layer (heat treated at 500 °C). The overlay shows the relative EDX signal intensity measured along the line marked by the two white arrows. For these intensities, only the elements La, Pb and Si were taken into account. (b) HRTEM image of the same cross-section, with indication of the (110) plane spacing in La₂O₂CO₃. The inset shows the FFT power spectrum for the PZT layer.

measurements. The (110) planes of PZT are perpendicular to the interface and parallel to the incident electron beam. Consequently, there is epitaxial growth in the observed region between the La₂O₂CO₃ buffer layer and the PZT thin film.

X-ray pole figure measurements are carried out to find the degree of orientation of the PZT thin films. The pole figure measurement of the (110) orientation at $2\theta = 31^\circ$ gives a circle, which indicates that the films are (100) oriented out-of-plane with no specific in-plane texturing (see the inset of Figure 2). This is related to the good lattice match between Ln₂O₂CO₃ and PZT on the one hand, and the absence of a driving force to orient the buffer layers in-plane, on the other hand. The (110) planes are aligned at an angle of 45° to the silicon substrates, with a fwhm of 6°. The measurements on La, Nd, Pr, and Sm based intermediate layers (thickness \approx 10 nm) produce very similar results. The experiments are repeated for different buffer layers based on Sm, Nd, Pr. They indicate the formation of Sm₂O₂CO₃ ($a = 3.974$ Å, $c = 12.92$ Å), Nd₂O₂CO₃ ($a = 3.98$ Å, $c = 15.605$ Å), and Pr₂O₂CO₃ ($a = 4.01$ Å, $c = 15.68$ Å) with a preferential out-of-plane orientation, and good lattice match (mismatch <1%) for all the buffer layers.

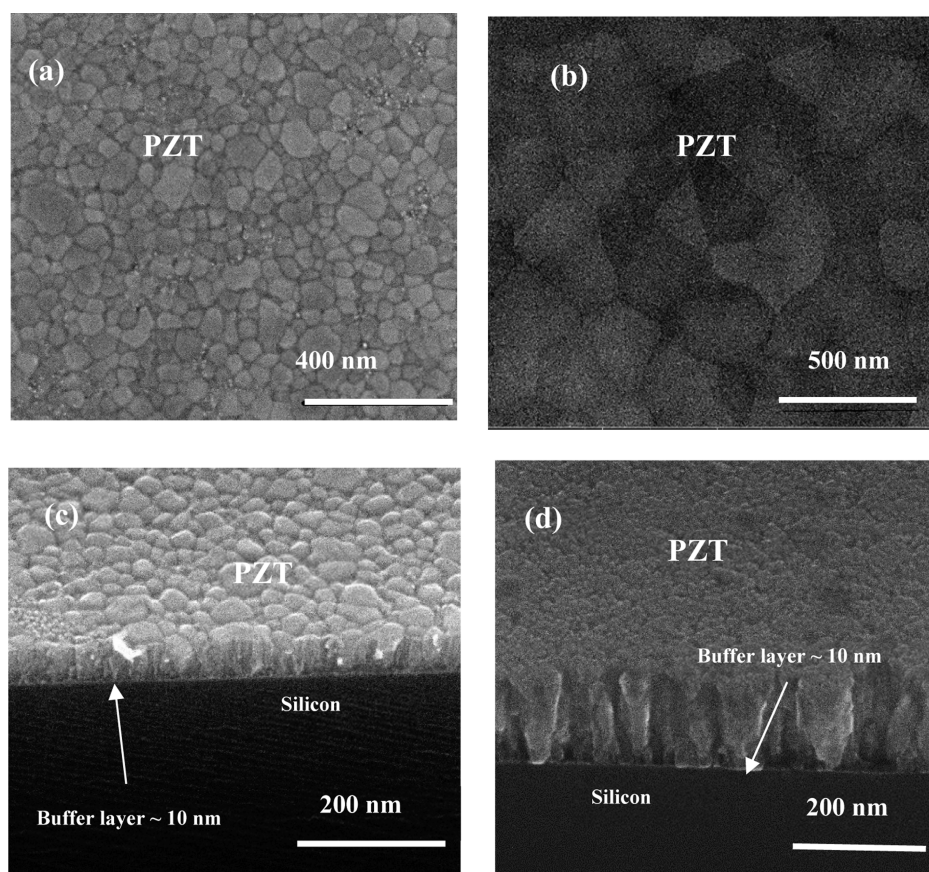


Figure 4. SEM top view of the PZT thin film (thickness ~ 200 nm, annealed at 630 $^{\circ}\text{C}$) deposited on silicon substrate, coated with a (a) Nd-based intermediate layer (thickness ≈ 10 nm, heat treated at 440 $^{\circ}\text{C}$). (b) La-based intermediate layer (thickness ≈ 10 nm, heat treated at 500 $^{\circ}\text{C}$). Cross-section image of PZT thin film (thickness ≈ 200 nm) (c) annealed at 630 $^{\circ}\text{C}$ (d) annealed at 560 $^{\circ}\text{C}$, on a silicon, coated with a La-based intermediate layer (thickness ≈ 10 nm, heat treated at 500 $^{\circ}\text{C}$).

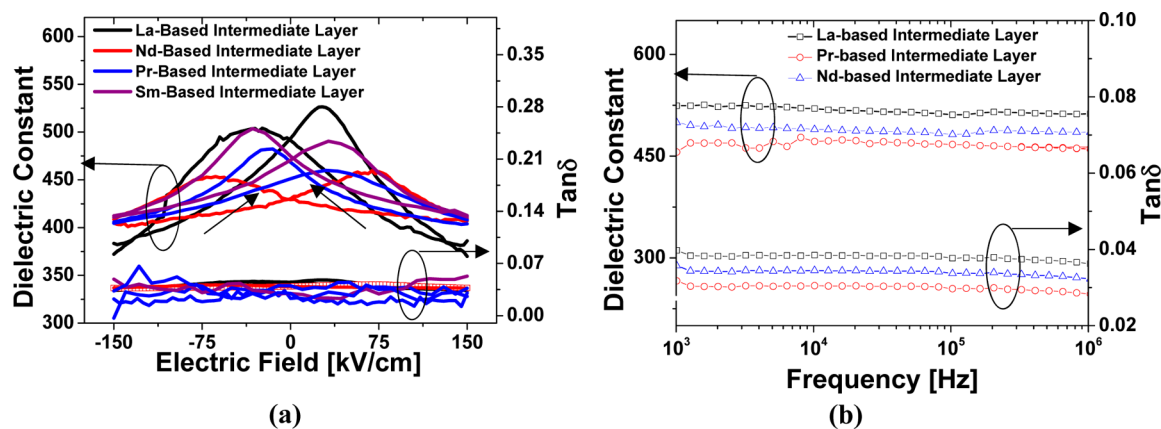


Figure 5. Small-signal ($V_{\text{ac}} = 0.1$ V, $f = 10$ kHz) relative dielectric constant of the PZT thin films (annealed at 630 $^{\circ}\text{C}$, thickness ~ 600 nm), on different template layers, (a) as a function of the DC bias voltage and (b) as a function of frequency ($E_{\text{dc}} = 0$ V).

Planar and cross sectional SEM images of representative PZT thin films deposited on Si, on different template layers and annealed at different temperature are shown in Figure 4.

The surface morphology of the films confirms smooth, dense and uniform polygonal grains without any obvious secondary phase. The average grain sizes of the PZT films deposited on Si, with intermediate template layers of Nd and La are estimated as 300 nm, and 80 nm, respectively. When the buffer layer thickness is below the critical thickness (buffer layer thickness < 5 nm), the deposited PZT films show micro cracks and pin-

holes on the film surface. The presence of the intercrystal voids and micro cracks increases the leakage current during the electrical measurements. These unwanted features are due to the thermal stress in the PZT thin films generated during multiple annealing steps, and the nonuniformities in the intermediate layers. The problem can be resolved by increasing the intermediate layer thickness. The cross sectional SEM images of the PZT shown as in Figure 4c, and Figure 4d exhibits dense and columnar grains because of the heterogeneous nucleation growth. This growth behavior can also be

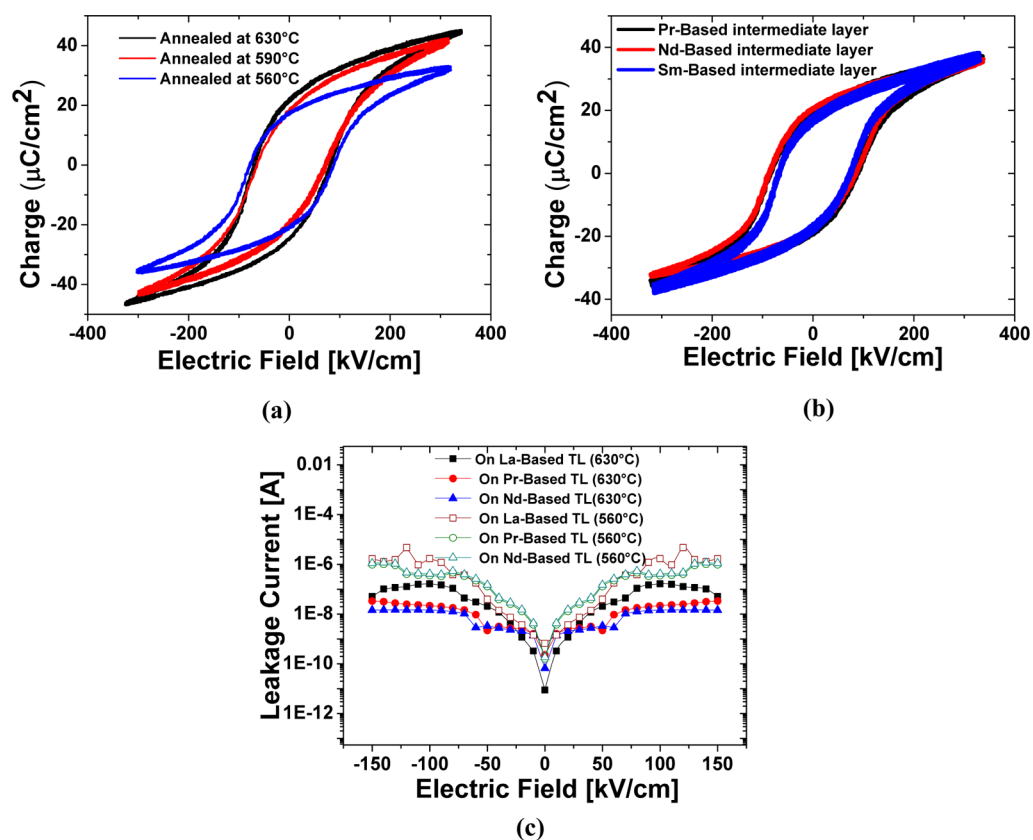


Figure 6. (a) P – E hysteresis measurements of the PZT thin films (thickness ~ 600 nm, annealed at 630 °C) (a) deposited on La-based intermediate layer annealed at different temperature (b) deposited on different buffer layers and annealed at 630 °C. The measurements are performed at 10 kHz. (c) Leakage current as a function of applied electric field for the PZT films deposited on different template layers, under different annealing treatments.

observed in the STEM imaging of a cross section (Figure 3). Micrometer-sized secondary phases like pyrochlore/fluorite phases are not observed in the SEM images.³⁴ These observations are also confirmed by the lack of corresponding diffraction peaks and by the well-defined electrical measurements. Also the presence of the thin intermediate layer is evident from the SEM measurement, and the thickness matches with the data from ellipsometry measurements. Atomic force microscopy (AFM) measurements are carried out to estimate the rms roughness of the PZT films. A $5 \mu\text{m}$ by $5 \mu\text{m}$ square area is taken into consideration for measuring the average rms roughness value (see Supporting Information). The measured rms value for the roughness on La-, Nd-, Pr-, and Sm-based intermediate layers are 2.4 , 2.2 , 2.8 , and 2.6 nm, respectively.

The capacitance–voltage (C – V) hysteresis loops of the PZT thin films on different template layers are illustrated in Figure 5a. The C – V measurement shows the small signal ($V_{\text{ac}} = 0.1$ V) capacitance as a function of the stepwise increased DC bias voltage. The measurements feature well-defined butterfly hysteresis loops that saturates at high electric fields with good dielectric tunability. Two maxima for the dielectric constants are observed depending on the direction of the electric field. The dielectric constant and the loss tangent extracted from the small signal analysis, in contrast to the large signal used in polarization–electric field (P – E) hysteresis measurements. We extract an effective dielectric constant from the capacitance which includes the effect of both the template and PZT layer. Two maxima for the dielectric constants are observed depending on the direction of the electric field. As seen from

Figure 5a, when the DC voltage increased from 0 to 200 kV/cm, the permittivity of the PZT films decreases from 540 to 360 , 455 to 400 , 502 to 413 , and 482 to 405 , for La-, Nd-, Pr-, and Sm-based template layers, respectively. The variations observed for the dielectric loss of the films is 0.045 , 0.02 , 0.04 , 0.36 (at 0 kV/cm) and 0.038 , 0.027 , 0.02 , 0.017 (at 200 kV/cm), respectively for PZT films on La-, Nd-, Pr-, and Sm-based template layers. Figure 5b plots the permittivity and dielectric loss tangent as a function of frequency ($V_{\text{ac}} = 0.1$ V) for the PZT thin films annealed at 630 °C, on La, Pr, and Nd template layers. The measurements show a steady response of the dielectric constant and loss tangent up to 1 MHz.

Figure 6a represents the P – E hysteresis measurements of the PZT thin films deposited on lanthanum based intermediate layers annealed at different temperatures. The measurements indicate well-saturated P – E hysteresis loops, with a breakdown strength up to 800 kV/cm. The remnant polarization (P_r) and coercive field (E_c) of the PZT films (thickness ~ 600 nm) on a La-based template annealed at 630 , 590 , and 560 °C are 25 , 19 , and $19 \mu\text{C}/\text{cm}^2$ and 70 , 68 , and 75 kV/cm, respectively. The results are comparable to strongly (100) textured epitaxial PZT thin films on LSCO/STO/Si substrate reported by Wang et al.,³⁵ with P_r of $20 \mu\text{C}/\text{cm}^2$, however with a smaller coercive field of 40 kV/cm. Figure 6b shows hysteresis measurements of the PZT films annealed at 630 °C on different intermediate layers. The PZT films exhibit a coercive field of 89 , 78 , 85 kV/cm and remnant polarization of 22 , 21 , and $20 \mu\text{C}/\text{cm}^2$, on Nd-, Sm-, and Pr-based intermediate layers, respectively. The leakage current with applied electric field in Figure 6c is in the

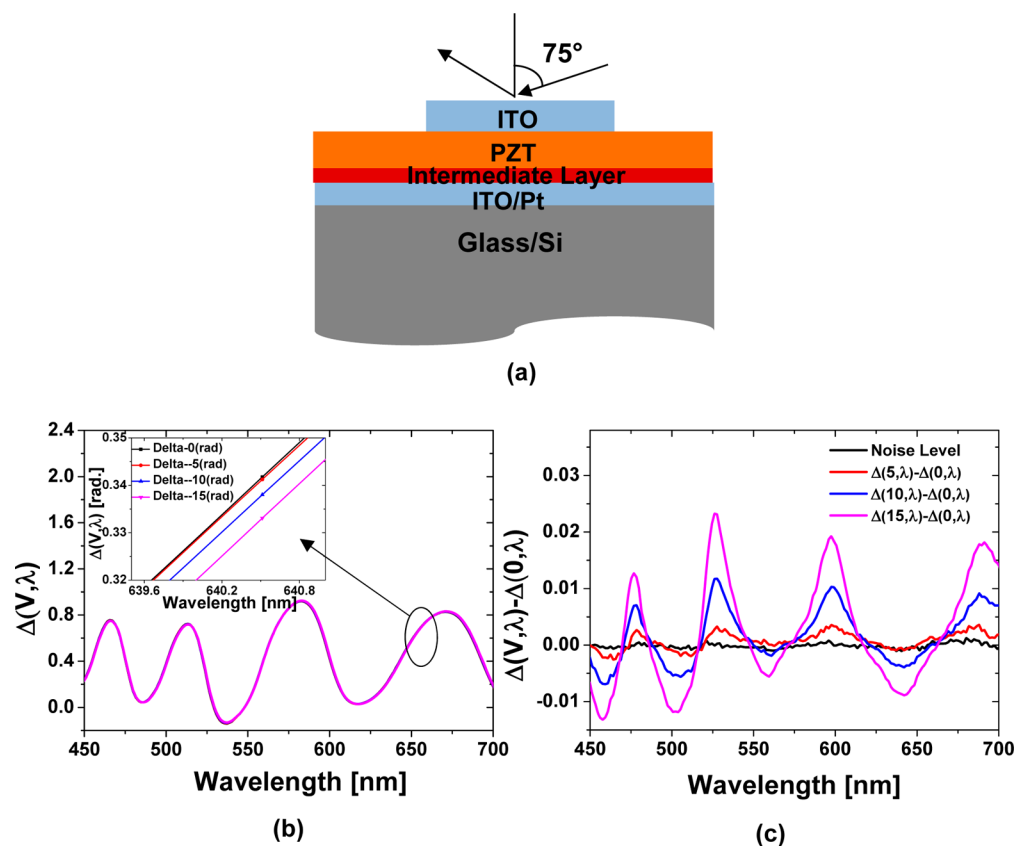


Figure 7. (a) Schematic representation of the sample stack and the incident light beams from the ellipsometer. (b) Observed variation in Δ , as a function of the applied voltage. (c) Change observed in $\Delta(V, \lambda) - \Delta(0, \lambda)$ at 0 V (Noise level) 5, 10, and 15 V.

order of $0.1 \mu\text{A}$ at 150 kV/cm for the PZT films annealed at $630 \text{ }^\circ\text{C}$ on different buffer layers. However, as the annealing temperature is decreased to $560 \text{ }^\circ\text{C}$, leakage current increases by an order of magnitude. The increase in the leakage current corresponds well with the decrease in the grain sizes seen in the SEM measurements for the samples annealed at lower temperatures.

Electro-optic Characterizations. A spectroscopic ellipsometry based approach has been used to estimate the electric field induced birefringence, similar to the method described in previous reports.^{36,37} With this method it is possible to extract an effective electro-optic (EO) coefficient without the need to do the full fitting of the layer stack parameters. PZT films of thickness 800 nm have been deposited on either ITO/glass substrates or Pt/Si substrates for the EO measurements. To facilitate the ellipsometry measurements, a top transparent conductive ITO thin film of thickness 30 nm is deposited, by e-beam evaporation and subsequent heat treatment at $300 \text{ }^\circ\text{C}$ to obtain sufficient conductivity and transparency of the ITO. The PZT films are structurally characterized prior to the electro-optic measurements. The X-ray diffraction measurements show strong preferential orientation along the (100) crystallographic direction with sharp diffraction peaks corresponding to the tetragonal PZT (52/48). The SEM measurements show well packed polygonal crystal grains, with an rms roughness of 3.1 nm as determined by AFM. To confine the light beam completely within the electrode, the top electrode is patterned to a size of $1.5 \text{ cm} \times 0.5 \text{ cm}$ using a metal shadow mask. The schematic representation of a typical sample layer stacks used for the electro-optic measurements are shown in Figure 7a. A DC voltage is applied between the top and bottom contact to

introduce a change in the refractive index inside the PZT film. Note that, we use a relatively large electrode size, but none of the good quality PZT films exhibited a breakdown for field strength up to 200 kV/cm . However, in our measurement the films are of such quality that the leakage current is on the order of 10^{-7} A which allows the prolonged electro-optic measurements without any dielectric breakdown (see the Supporting Information). The light is incident under an angle of 75° onto the ITO (30 nm)/PZT (800 nm)/ $\text{La}_2\text{O}_2\text{CO}_3$ (10 nm)/ITO/Glass sample for the ellipsometry measurements. The measurement gives a value for the ellipsometric angles ψ and Δ , which are used to define the complex reflectance ratio of the P- to the S-polarized light.

$$r_p/r_s = \tan(\psi) \times \exp(i\Delta)$$

where the $\tan \psi$ is the amplitude reflectance ratio and Δ is the phase shift between the p- and s-polarized light after reflection. In the conventional procedure for analyzing the ellipsometry data, the dielectric function are numerically optimized for each of the layers assuming a certain dispersion relation.³⁶ The dielectric function of each layer arises from a fitting procedure considering the transmission, reflection, and absorption of the light on all possible interfaces. However, each layer needs to be modeled very precisely to extract the small variations introduced by the application of electric fields. The optimization of the model is carried out until the residual mean square is converged to the minimum. However, this method is very tedious in our sample structures as at least 10 parameters (n and k for each of the 5 layers) need to be optimized simultaneously.

To model the small variations in the refractive index, induced by an applied electric field, we followed a method of differentiating the phase reflectance ratio (Δ) obtained from the ellipsometry measurements. We assume that the variations of the ellipsometry Δ angles are only the result of the changes in the refractive index inside the PZT film, and that absorption does not play a role in modeling the Δ angles. According to previous reports the contribution to the phase change by the thickness variation in PZT film because of the piezoelectric effect is negligible compared to that of the refractive index change.³⁸ As the variation expected in the refractive index is in the order of 10^{-3} , it is assumed that the reflections from the different layer boundaries have not introduced any phase variations in the Δ angles with applied voltages.

Figure 7a represents the ellipsometry Δ angles measured for the ITO/PZT/La₂O₂CO₃/ITO/glass sample. The value of Δ at different applied electric fields indicates clear variation with applied voltage. The close up of the pattern observed in the range of 639–641 nm clearly demonstrates the changes observed in Δ . The Δ angle at a given electric field $\Delta(V, \lambda)$ shows a clear shift with the applied electric field, with reference to the value for Δ at 0 V ($\Delta(0, \lambda)$), clearly indicating the linear EO Pockels effect from the film. The variation observed in the Δ angle at three different voltages are shown in Figure 7c.

The background noise in the measurements correspond to the uncertainty in the experimental measurement of the ellipsometry angles, which may originate from fluctuations in the intensity of incident light over time. The influence of the noise on the Δ spectrum is estimated by mutually subtracting two Δ spectrum at the same voltage (see Supporting Information). It is clear that the changes due to voltage are well above the noise level in the Δ spectrum, which confirms the electric field introduced phase change.

The method consists of estimating the effective wavelength change in PZT because of the change in the refractive index. To evaluate this, we differentiate the Δ angle, assuming that all other parameters except the optical permittivity tensor of (PZT) remain the same. We obtained small changes in the effective wavelength caused by the change refractive index $n(\text{PZT})$, corresponding to small variation in the applied voltage using the equation

$$\Delta\lambda = \left[\frac{\frac{\partial\Delta(V, \lambda)}{\partial V}}{\frac{\partial\Delta(0, \lambda)}{\partial\lambda}} \right] \times dV$$

The $(\partial\Delta(0, \lambda)/\partial\lambda)$ spectrum is obtained from the $\Delta(0, \lambda)$ spectrum (see the Supporting Information), by calculating $\Delta(0, \lambda) - \Delta(0, \lambda + 0.006 \mu\text{m})$. It is noted that the spectrum resembles the $(\partial\Delta(V, \lambda)/\partial\lambda)$ spectrum except for the different amplitude. Since a wavelength shift of $0.006 \mu\text{m}$ corresponds to the oscillatory spectrum in $(\partial\Delta(0, \lambda)/\partial\lambda)$, by comparison we can extract the effective wavelength shift in the actual oscillatory function given in Figure 7c. The $(\partial\Delta(0, \lambda)/\partial\lambda)$, $(\partial\Delta(V, \lambda)/\partial\lambda)$ and the noise level spectrums are plotted in (see the Supporting Information Figure S3c–e). Since the effective wavelength of the light propagating in a medium of refractive index n is given by λ/n , the change in the wavelength observed is converted to corresponding Δn through $\Delta n = (n/\lambda)\Delta\lambda$. Finally, the effective pockels coefficients are determined from Δn , using

$$\Delta n = \frac{1}{2} \times n^3 \times r_{\text{eff}} \times E$$

Figure 8a and b represents the electric field refractive index change and the corresponding effective pockels coefficient of

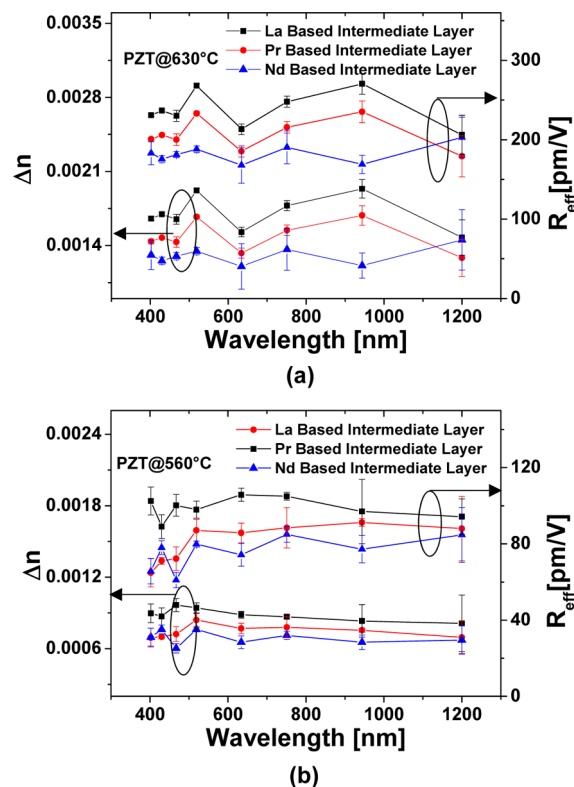


Figure 8. Refractive index change and the effective electro optic coefficients of the PZT thin film (thickness ~ 800 nm) annealed at (a) 630 and (b) 560 °C, on different lanthanide based template layers.

the PZT thin films deposited on different lanthanide based template layers with 10 nm thickness annealed at different temperature. The films possess strong effective EO coefficients. The graph indicates which annealing temperature and buffer layer properties result in the highest EO coefficient. The PZT films annealed at 630 °C on La, Pr and Nd buffer layers exhibit a linear pockels coefficient of 240, 215, and 200 pm/V, respectively, at the wavelength of 630 nm. Even though a significant change in the pockels effects is observed by reducing the annealing temperature to 560 °C, the electro-optic effects of the films are still comparable to previously reported results with the films annealed above 600 °C.³⁹ The pockels coefficient of the films annealed at 560 °C are reduced to 115 pm/V, 96 pm/V and 89 pm/V for the films deposited on La, Pr and Nd intermediate layers. The effective linear electro-optic coefficients (r_{eff}) measured here are comparable to the previously reported values. Epitaxially grown (100) oriented PZT (52/48) thin films on a Nd:STO (100) substrate show an r_{eff} of 165 pm/V.³⁶ Masuda et al.⁴⁰ has demonstrated further improvement in r_{eff} up to 498 pm/V for epitaxial (111) oriented PZT (52/48) thin film on Nd:STO (111) substrate by controlling the crystal phases in the films with a modified annealing procedure and an electro-optic modulator of 40 GHz speed is also demonstrated with this method.⁴¹ Even though a strong electro-optic properties of the PZT thin films are demonstrated on different substrates, only few reports are on silicon.⁴² State-of-art PZT/Si photonic devices use the piezo-electric properties of the film, to break the Si crystal symmetry and to introduce the birefringence in the Si.^{43,44} However, the change in the

refractive index observed in these devices are an order of magnitude smaller compared to the electro-optics effects measured here.

CONCLUSION

In conclusion, a novel strategy for fabricating highly textured PZT thin films on silicon has been developed, by utilizing a chemical solution deposition route. We have developed a number of novel ultrathin lanthanide based intermediate layers, as template layers for textured thin film growth on different substrates. The structural characterizations of the films demonstrate strong preferential thin film growth, with well packed, crack free polygonal crystal grains. The PZT thin films have a strong columnar structure with a high degree of orientation (>99.8%) regardless of the thin film growth conditions. The dielectric constant measurement of the films shows the expected trend with a large dielectric constant ~ 600 (scaled by the buffer layer thickness, dielectric constant, and electrode parameters). The hysteresis and leakage current measurement shows low coercive field, strong remnant polarization, and large breakdown voltage. Strong electro-optic properties of the as-deposited thin films (ranging from 120 to 240 pm/V), estimated by the ellipsometry technique, indicate that this PZT film is an ideal candidate for silicon nanophotonics EO modulators. The novel deposition method offers a low cost and simple method to produce good quality, strongly electro-optic PZT thin films on crystalline and amorphous (SiO_2 and Si_3N_4) substrates for a variety of integrated photonics and electronics applications, where the properties of the films can be tuned for applications spanning from microwave to the optical frequencies.

ASSOCIATED CONTENT

Supporting Information

Some details of the X-ray diffraction measurements, pole figures, atomic force microscopy (AFM) measurements and the details of the electro-optic characterization of the PZT films. The Supporting Information is available free of charge on the ACS Publications website at DOI: 10.1021/acsami.5b01781.

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Notes

The authors declare no competing financial interest.

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REFERENCES

- (1) Kobayashi, T.; Oyama, S.; Takahashi, M.; Maeda, R.; Itoh, T. Microelectromechanical Systems-Based Electrostatic Field Sensor Using $\text{Pb}(\text{Zr,Ti})\text{O}_3$ Thin Films. *Jpn. J. Appl. Phys.* **2008**, *47*, 7533.
- (2) Xiao, B.; Avrutin, V.; Liu, H. Y.; Ozgur, U.; Morkoc, H.; Lu, C. Z. Large Pyroelectric Effect in Undoped Epitaxial $\text{Pb}(\text{Zr,Ti})\text{O}_3$ Thin Films on SrTiO_3 Substrates. *Appl. Phys. Lett.* **2008**, *93*, No. 052913.
- (3) Lei, X. Y.; Remiens, D.; Sama, N.; Chen, Y.; Mao, C. L.; Dong, X. L.; Wang, G. S. Dielectric, Ferroelectric and Piezoelectric Properties of 100-Oriented $\text{Pb}_{0.4}\text{Sr}_{0.6}\text{TiO}_3$ Thin Film Sputtered on LaNiO_3 Electrode. *J. Cryst. Growth* **2012**, *347*, 15.
- (4) Zhu, M. M.; Du, Z. H.; Ma, J. Influence of Crystal Phase and Transparent Substrates on Electro-Optic Properties of Lead Zirconate Titanate Films. *J. Appl. Phys.* **2010**, *108*, No. 113119.
- (5) Eom, C. B.; Trolier-McKinstry, S. Thin-Film Piezoelectric MEMS. *MRS Bull.* **2012**, *37*, 1007–1021.
- (6) Sriram, S.; Bhaskaran, M.; Holland, A. S.; Short, K. T.; Latella, B. A. Measurement of High Piezoelectric Response of Strontium-Doped Lead Zirconate Titanate Thin Films Using a Nanoindenter. *J. Appl. Phys.* **2007**, *101*, No. 104910.
- (7) Bin, C.; Zhenghu, Z.; Yiwei, L.; Qing-Feng, Z.; Yali, X.; Huali, Y.; Guohong, D.; Zhixiang, L.; Gaojie, X.; Run-Wei, L. Tunable Photovoltaic Effects in Transparent $\text{Pb}(\text{Zr}_{0.53}\text{Ti}_{0.47})\text{O}_3$ Capacitors. *Appl. Phys. Lett.* **2012**, *100*, No. 173903.
- (8) Luo, C.; Cao, G. Z.; Shen, I. Y. Development of a Lead-Zirconate-Titanate (PZT) Thin-Film Microactuator Probe for Intracochlear Applications. *Sens. Actuators, A* **2013**, *201*, 1–9.
- (9) Thapliya, R.; Okano, Y.; Nakamura, S. Electrooptic Characteristics of Thin-Film PLZT Waveguide Using Ridge-Type Mach-Zehnder Modulator. *J. Lightwave Technol.* **2003**, *21*, 1820–1827.
- (10) Xiong, C.; Pernice, W. H. P.; Ngai, J. H.; Reiner, J. W.; Kumah, D.; Walker, F. J.; Ahn, C. H.; Tang, H. X. Active Silicon Integrated Nanophotonics: Ferroelectric BaTiO_3 Devices. *Nano Lett.* **2014**, *14*, 1419–1425.
- (11) Kim, J.; Yang, S. A.; Choi, Y. C.; Han, J. K.; Jeong, K. O.; Yun, Y. J.; Kim, D. J.; Yang, S. M.; Yoon, D.; Cheong, H.; Chang, K. S.; Noh, T. W.; Bu, S. D. Ferroelectricity in Highly Ordered Arrays of Ultra-Thin-Walled $\text{Pb}(\text{Zr,Ti})\text{O}_3$ Nanotubes Composed of Nanometer-Sized Perovskite Crystallites. *Nano Lett.* **2008**, *8*, 1813–1818.
- (12) Datta, A.; Mukherjee, D.; Witanachchi, S.; Mukherjee, P. Hierarchically Ordered Nano-Heterostructured PZT Thin Films with Enhanced Ferroelectric Properties. *Adv. Funct. Mater.* **2014**, *24*, 2638–2647.
- (13) Chen, X.; Xu, S. Y.; Yao, N.; Shi, Y. 1.6 V Nanogenerator for Mechanical Energy Harvesting Using PZT Nanofibers. *Nano Lett.* **2010**, *10*, 2133–2137.
- (14) Datta, A.; Mukherjee, D.; Hordagoda, M.; Witanachchi, S.; Mukherjee, P.; Kashid, R. V.; More, M. A.; Joag, D. S.; Chavan, P. G. Controlled Ti Seed Layer Assisted Growth and Field Emission Properties of $\text{Pb}(\text{Zr}_{0.52}\text{Ti}_{0.48})\text{O}_3$ Nanowire Arrays. *ACS Appl. Mater. Interfaces* **2013**, *5*, 6261–6267.
- (15) Tang, P. S.; Towner, D. J.; Hamano, T.; Meier, A. L.; Wessels, B. W. Electrooptic Modulation up to 40 GHz in a Barium Titanate Thin Film Waveguide Modulator. *Opt. Express* **2004**, *12*, 5962–5967.
- (16) Wooten, E. L.; Kissa, K. M.; Yi-Yan, A.; Murphy, E. J.; Lafaw, D. A.; Hallemeier, P. F.; Maack, D.; Attanasio, D. V.; Fritz, D. J.; McBrien, G. J.; Bossi, D. E. A Review of Lithium Niobate Modulators for Fiber-Optic Communications Systems. *IEEE J. Sel. Top. Quantum Electron.* **2000**, *6*, 69–82.
- (17) Rabiei, P.; Ma, J. C.; Khan, S.; Chiles, J.; Fathpour, S. Heterogeneous Lithium Niobate Photonics on Silicon Substrates. *Opt. Express* **2013**, *21*, 25573–25581.
- (18) Masuda, S.; Seki, A.; Shiota, K.; Masuda, Y. Mach-Zehnder Interferometer-Type Photonic Switches Based on Epitaxially Grown Lanthanum-Modified Lead Zirconate Titanate Films. *J. Lightwave Technol.* **2011**, *29*, 209–214.
- (19) Abel, S.; Stoeferle, T.; Marchiori, C.; Rossel, C.; Rossell, M. D.; Erni, R.; Caimi, D.; Sousa, M.; Chelnokov, A.; Offrein, B. J.; Fompeyrine, J. A Strong Electro-Optically Active Lead-Free Ferroelectric Integrated on Silicon. *Nat. Commun.* **2014**, *4*, 1–6.
- (20) Cooney, T. G.; Francis, L. F. Processing of Sol–Gel Derived PZT Coatings on Non-Planar Substrates. *J. Micromech. Microeng.* **1996**, *6*, 291–300.
- (21) Frunza, R.; Ricinschi, D.; Gheorghiu, F.; Apetrei, R.; Luca, D.; Mitoseriu, L.; Okuyama, M. Preparation and Characterisation of PZT Films by RF-Magnetron Sputtering. *J. Alloy. Compd.* **2011**, *509*, 6242–6246.
- (22) Menou, N.; Funakubo, H. (111)-Oriented $\text{Pb}(\text{Zr,Ti})\text{O}_3$ Films Deposited on SrRuO_3/Pt Electrodes: Reproducible Preparation by

Metal Organic Chemical Vapor Deposition, Top Electrode Influence, and Reliability. *J. Appl. Phys.* **2007**, *102*, No. 114105.

(23) Borowiak, A. S.; Niu, G.; Pillard, V.; Agnus, G.; Lecoeur, P.; Albertini, D.; Baboux, N.; Gautier, B.; Vilquin, B. Pulsed Laser Deposition of Epitaxial Ferroelectric Pb(Zr,Ti)O₃ Films on Silicon Substrates. *Thin Solid Films* **2012**, *520*, 4604–4607.

(24) Lin, Y.; Zhao, B. R.; Peng, H. B.; Xu, B.; Chen, H.; Wu, F.; Tao, H. J.; Zhao, Z. X.; Chen, J. S. Growth and Polarization Features of Highly (100) Oriented Pb(Zr_{0.53}Ti_{0.47})O₃ Films on Si with Ultrathin SiO₂ Buffer Layer. *Appl. Phys. Lett.* **1998**, *73*, 2781–2783.

(25) Chen, L.; Shen, M. R.; Fang, L.; Xu, Y. Microstructure Control of (Pb,Sr)TiO₃ Films on Pt/Ti/SiO₂/Si Substrates by a TiO₂ Buffer Layer. *Thin Solid Films* **2008**, *516*, 1285–1289.

(26) Yu, J.; Meng, X. J.; Sun, J. L.; Huang, Z. M.; Chu, J. H. Optical and Electrical Properties of Highly (100)-Oriented PbZr_{1-x}Ti_xO₃ Thin Films on the LaNiO₃ Buffer Layer. *J. Appl. Phys.* **2004**, *96*, 2792–2799.

(27) Shih, W. C.; Yen, Z. Z.; Liang, Y. S. Preparation of Highly *c*-Axis-Oriented PZT Films on Si Substrate with Mgo Buffer Layer by the Sol–Gel Method. *J. Phys. Chem. Solids* **2008**, *69*, 593–596.

(28) Chen, L.; Reano, R. M. Compact Electric Field Sensors Based on Indirect Bonding of Lithium Niobate to Silicon Microrings. *Opt. Express* **2012**, *20*, 4032–4038.

(29) Kim, D. M.; Eom, C. B.; Nagarajan, V.; Ouyang, J.; Ramesh, R.; Vaithyanathan, V.; Schlom, D. G. Thickness Dependence of Structural and Piezoelectric Properties of Epitaxial Pb(Zr_{0.52}Ti_{0.48})O₃ Films on Si and SrTiO₃ Substrates. *Appl. Phys. Lett.* **2006**, *88*, No. 142904.

(30) Balboul, B. A. A.; Myhoub, A. Y. Z. The Characterization of the Formation Course of Neodymium Oxide from Different Precursors: A Study of Thermal Decomposition and Combustion Processes. *J. Anal. Appl. Pyrolysis* **2010**, *89*, 95–101.

(31) Klingenberg, B.; Vannice, M. A. Influence of Pretreatment on Lanthanum Nitrate, Carbonate, and Oxide Powders. *Chem. Mater.* **1996**, *8*, 2755–2768.

(32) Shirsat, A. N.; Ali, M.; Kaimal, K. N. G.; Bharadwaj, S. R.; Das, D. Thermochemistry of La₂O₂CO₃ Decomposition. *Thermochim. Acta* **2003**, *399*, 167–170.

(33) Olafsen, A.; Fjellvag, H. Synthesis of Rare Earth Oxide Carbonates and Thermal Stability of Nd₂O₂CO₃. *J. Mater. Chem.* **1999**, *9*, 2697–2702.

(34) Lefevre, M. J.; Speck, J. S.; Schwartz, R. W.; Dimos, D.; Lockwood, S. J. Microstructural Development in Sol–Gel Derived Lead Zirconate Titanate Thin Films: The Role of Precursor Stoichiometry and Processing Environment. *J. Mater. Res.* **1996**, *11*, 2076–2084.

(35) Wang, Y.; Ganpule, C.; Liu, B. T.; Li, H.; Mori, K.; Hill, B.; Wuttig, M.; Ramesh, R.; Finder, J.; Yu, Z.; Droopad, R.; Eisenbeiser, K. Epitaxial Ferroelectric Pb(Zr,Ti)O₃ Thin Films on Si Using SrTiO₃ Template Layers. *Appl. Phys. Lett.* **2002**, *80*, 97–99.

(36) Kang, T. D.; Xiao, B.; Avrutin, V.; Ozigur, U.; Morkoc, H.; Park, J. W.; Lee, H. S.; Lee, H.; Wang, X. Y.; Smith, D. J. Large Electro-Optic Effect in Single-Crystal Pb(Zr,Ti)O₃ (001) Measured by Spectroscopic Ellipsometry. *J. Appl. Phys.* **2008**, *104*, No. 093103.

(37) Akazawa, H.; Shimada, M. Spectroellipsometric Approach to Determine Linear Electro-Optic Coefficient of C-Axis-Oriented LiNbO₃ Thin Films. *J. Appl. Phys.* **2005**, *98*, No. 113501.

(38) Spirin, V. V.; Lee, C. H.; No, K. S. Measurement of the Pockels Coefficient of Lead Zirconate Titanate Thin Films by a Two-Beam Polarization Interferometer with a Reflection Configuration. *J. Opt. Soc. Am. B* **1998**, *15*, 1940–1946.

(39) Lee, C.; Spirin, V.; Song, H.; No, K. Drying Temperature Effects on Microstructure, Electrical Properties and Electro-Optic Coefficients of Sol–Gel Derived PZT Thin Films. *Thin Solid Films* **1999**, *340*, 242–249.

(40) Masuda, S.; Seki, A.; Masuda, Y. Influence of Crystal Phases on Electro-Optic Properties of Epitaxially Grown Lanthanum-Modified Lead Zirconate Titanate Films. *Appl. Phys. Lett.* **2010**, *96*, No. 072901.

(41) Masuda, S.; Seki, A.; Shiota, K.; Hara, H.; Masuda, Y. Electro-Optic and Dielectric Characterization of Ferroelectric Films for High-

Speed Optical Waveguide Modulators. *J. Appl. Phys.* **2011**, *109*, No. 124108.

(42) Kurihara, K.; Kondo, M.; Sato, K.; Ishii, M.; Wakiya, N.; Shinozaki, K. Electrooptic Properties of Epitaxial Lead Zirconate Titanate Films on Silicon Substrates. *Jpn. J. Appl. Phys., Part 1* **2007**, *46*, 6929–6932.

(43) Sebbag, Y.; Goykhman, I.; Desiatov, B.; Nachmias, T.; Yoshaei, O.; Kabla, M.; Meltzer, S. E.; Levy, U. Bistability in Silicon Microring Resonator Based on Strain Induced by a Piezoelectric Lead Zirconate Titanate Thin Film. *Appl. Phys. Lett.* **2012**, *100*, No. 141107.

(44) Tsia, K. K.; Fathpour, S.; Jalalia, B. Electrical Tuning of Birefringence in Silicon Waveguides. *Appl. Phys. Lett.* **2008**, *92*, No. 061109.